



IFW

In RE application of Y. MIYAKI et al  
Serial No.: 10/644,919

Group Art Unit: 2814

Filed: August 21, 2003

Examiner: D. Nguyen

## Title: SEMICONDUCTOR DEVICE AND ITS MANUFACTURING METHOD

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Transmitted herewith is an Amendment in the above-identified application.

Small entity status of this application under 37 CFR 1.9 and 1.27 has been established by a verified statement previously submitted.

A verified statement to establish small entity status under 37 CFR 1.9 and 1.27 is enclosed.

No additional fee is required.

The fee has been calculated as shown below:

|  | (COL. 1) | (COL. 2)    | (COL. 3) |
|--|----------|-------------|----------|
| Total  | * 6      | Minus ** 20 | = 0      |
| Indep.   | * 2      | Minus *** 3 | = 0      |
| <input type="checkbox"/> First Presentation of Multiple Dependent Claims |          |             |          |

## SMALL ENTITY

| Rate  | Additional Fee |
|-------|----------------|
| x 9   | \$             |
| x 42  | \$             |
| + 140 | \$             |
| Total | \$             |

## OTHER THAN A SMALL ENTITY

| Rate  | Additional Fee |
|-------|----------------|
| x 18  | \$ 0           |
| x 84  | \$ 0           |
| + 280 | \$ 0           |
| Total | \$ 0           |

\* If the entry in Col. 1 is less than the entry in Col. 2, write '0' in Col. 3.  
 \*\* If the 'Highest Number Previously Paid For' IN THIS SPACE is less than 20, write '20' in this space.  
 \*\*\* If the 'Highest Number Previously Paid For' IN THIS SPACE is less than 3, write '3' in this space.  
 The 'Highest Number Previously Paid For' (Total or Independent) is the highest number found from the equivalent box in Col. 1 of a prior Amendment or the number of claims originally filed.

Please charge my Deposit Account No. 50-1417 in the amount of \$ \_\_\_\_\_.

A check in the amount of \$ \_\_\_\_\_ is attached in payment of: \_\_\_\_\_.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-1417.

Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Any patent application processing fees under 37 CFR 1.17.

Any Extension of Time fees that are necessary, which are hereby requested if necessary.

MATTINGLY, STANGER & MALUR, P.C.  
1800 Diagonal Rd., Suite 370  
Alexandria, Virginia 22314  
(703) 684-1120

By:

  
Daniel J. Stanger  
Registration No. 32,846  
Attorney for Applicant(s)

Date: June 18, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Y. MIYAKI et al

Serial No. 10/644,919

Group Art Unit: 2814

Filed: August 21, 2003

Examiner: D. Nguyen

For: SEMICONDUCTOR DEVICE AND ITS MANUFACTURING METHOD

REPLY

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed March 18, 2004,  
please amend the above-identified application as follows.



IN THE TITLE

Please amend the title of the invention to -- METHOD OF  
MANUFACTURING A SEMICONDUCTOR DEVICE HAVING LEADS STABILIZED  
DURING DIE MOUNTING--.